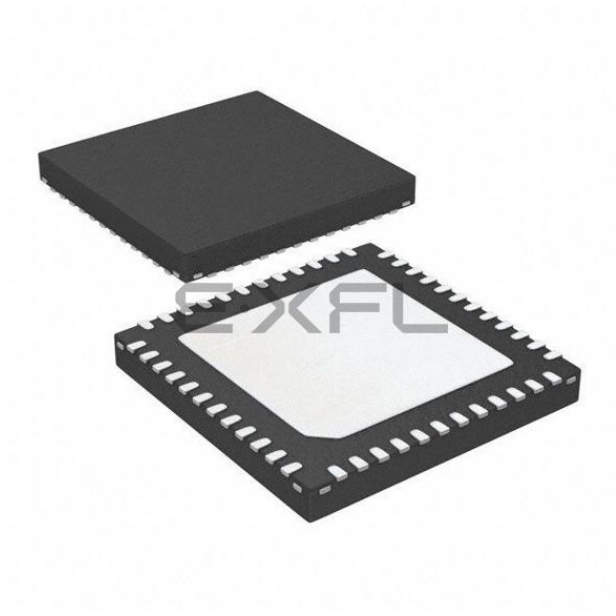
Renesas Electronics America Inc - R5F52316CDNE#U0 Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	RXv2
Core Size	32-Bit Single-Core
Speed	54MHz
Connectivity	I²C, IrDA, SCI, SD/SDIO, SPI, SSI, USB OTG
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	30
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	32K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 8x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-WFQFN Exposed Pad
Supplier Device Package	48-HWQFN (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f52316cdne-u0

Table 1.1 Outline of Specifications (3/4)

Classification	Module/Function	Description
Timers	Independent watchdog timer (IWDTa)	• 14 bits × 1 channel • Count clock: Dedicated low-speed on-chip oscillator for the IWDT Frequency divided by 1, 16, 32, 64, 128, or 256
	Realtime clock (RTCe)	• Clock source: Sub-clock • Time/calendar • Interrupts: Alarm interrupt, periodic interrupt, and carry interrupt • Time-capture facility for three values
	Low power timer (LPT)	• 16 bits × 1 channel • Clock source: Sub-clock, Dedicated low-speed on-chip oscillator for the IWDT Frequency divided by 2, 4, 8, 16, or 32
	8-bit timer (TMR)	• (8 bits × 2 channels) × 2 units • Seven internal clocks (PCLK/1, PCLK/2, PCLK/8, PCLK/32, PCLK/64, PCLK/1024, and PCLK/8192) and an external clock can be selected • Pulse output and PWM output with any duty cycle are available • Two channels can be cascaded and used as a 16-bit timer
Communication functions	Serial communications interfaces (SCIg, SCIh)	• 7 channels (channel 0, 1, 5, 6, 8, 9: SCIg, channel 12: SCIh) • SCIg Serial communications modes: Asynchronous, clock synchronous, and smart-card interface Multi-processor function On-chip baud rate generator allows selection of the desired bit rate Choice of LSB-first or MSB-first transfer Average transfer rate clock can be input from TMR timers for SCI5, SCI6, and SCI12 Start-bit detection: Level or edge detection is selectable. Simple I^2C Simple SPI 9-bit transfer mode Bit rate modulation Event linking by the ELC (only on channel 5) • SCIh (The following functions are added to SCIg) Supports the serial communications protocol, which contains the start frame and information frame Supports the LIN format
	IrDA interface (IRDA)	• 1 channel (SCI5 used) • Supports encoding/decoding of waveforms conforming to IrDA standard 1.0
	I^2C bus interface (RIICa)	• 1 channel • Communications formats: I^2C bus format/SMBus format • Master mode or slave mode selectable • Supports fast mode
	Serial peripheral interface (RSPIa)	• 1 channel • Transfer facility Using the MOSI (master out, slave in), MISO (master in, slave out), SSL (slave select), and RSPCK (RSPI clock) enables serial transfer through SPI operation (four lines) or clock-synchronous operation (three lines) • Capable of handling serial transfer as a master or slave • Data formats • Choice of LSB-first or MSB-first transfer The number of bits in each transfer can be changed to 8, 9, 10, 11, 12, 13, 14, 15, 16, 20, 24, or 32 bits. 128-bit buffers for transmission and reception Up to four frames can be transmitted or received in a single transfer operation (with each frame having up to 32 bits) • Double buffers for both transmission and reception
	USB 2.0 host/function module (USBd)	• USB Device Controller (UDC) and transceiver for USB 2.0 are incorporated. • Host/function module: 1 port • Compliant with USB version 2.0 • Transfer speed: Full-speed (12 Mbps), low-speed (1.5 Mbps) • OTG (ON-The-Go) is supported. • Isochronous transfer is supported. • BC1.2 (Battery Charging Specification Revision 1.2) is supported. • Internal power supply for USB (allows operation without external power input to the VCC_USB pin when VCC = 4.0 to 5.5V)
	CAN module (RSCAN)	• 1 channel • Compliance with the ISO11898-1 specification (standard frame and extended frame) • 16 Message boxes

Table 1.1 Outline of Specifications (4/4)

Classification	Module/Function	Description
Communication functions	Serial Sound Interface (SSI)	• 1 channel • Capable of duplex communications • Various serial audio formats supported • Master/slave function supported • Programmable word clock or bit clock generation function • 8/16/18/20/22/24/32-bit data formats supported • On-chip 8-stage FIFO for transmission/reception • Supports WS continue mode in which the SSIWS signal is not stopped.
	SD Host Interface (SDHIa)	• 1 channel • Transfer speed : Default speed mode (8MB/s) • SD memory card interface (1 bit / 4bits SD bus) • MMC, eMMC Backward-compatible are supported. • SD Specifications Part 1: Compliant with Physical Layer Specification Ver.3.01 (Not support DDR) Part E1: SDIO Specification Ver. 3.00 • Error check function: CRC7 (command), CRC16 (data) • Interrupt Source: Card access interrupt, SDIO access interrupt, Card detection interrupt, SD buffer access interrupt • DMA transfer sources: SD_BUF write, SD_BUF read • Card detection, Write protection
Encryption functions	Trusted Secure IP (TSIP-Lite)	• Access management circuit • Encryption engine 128- or 256-bit key sizes of AES Block cipher mode of operation: GCM, ECB, CBC, CMAC, XTS, CTR, GCTR • Hash function • True random number generator • Prevention from illicit copying of a key
12-bit A/D converter (S12ADE)		• 12 bits (24 channels × 1 unit) • 12-bit resolution • Minimum conversion time: 0.83 µs per channel when the ADCLK is operating at 54 MHz • Operating modes Scan mode (single scan mode, continuous scan mode, and group scan mode) Group A priority control (only for group scan mode) • Sampling variable Sampling time can be set up for each channel. • Self-diagnostic function • Double trigger mode (A/D conversion data duplicated) • Detection of analog input disconnection • A/D conversion start conditions A software trigger, a trigger from a timer (MTU, TPU), an external trigger signal, or ELC • Event linking by the ELC
Temperature sensor (TEMPSA)		• 1 channel • The voltage output from the temperature sensor is converted into a digital value by the 12-bit A/D converter.
12-bit D/A converter (R12DAA)		• 2 channels • 12-bit resolution • Output voltage: 0.4 to AVCC0-0.5V
CRC calculator (CRC)		• CRC code generation for arbitrary amounts of data in 8-bit units • Select any of three generating polynomials: $X^8 + X^2 + X + 1$, $X^{16} + X^{15} + X^2 + 1$, or $X^{16} + X^{12} + X^5 + 1$ • Generation of CRC codes for use with LSB-first or MSB-first communications is selectable.
Comparator B (CMPBa)		• 2 channels × 2 units • Function to compare the reference voltage and the analog input voltage • Window comparator operation or standard comparator operation is selectable
Capacitive touch sensing unit (CTSU)		Detection pin: 24 channels
Data operation circuit (DOC)		Comparison, addition, and subtraction of 16-bit data
Power supply voltages/Operating frequencies		VCC = 1.8 to 2.4 V: 8 MHz, VCC = 2.4 to 2.7 V: 16 MHz, VCC = 2.7 to 5.5 V: 54 MHz
Operating temperature range		D version: –40 to +85°C, G version: –40 to +105°C
Packages		100-pin TFLGA (PTLG0100KA-A) 5.5 × 5.5 mm, 0.5 mm pitch 100-pin LFQFP (PLQP0100KB-B) 14 × 14 mm, 0.5 mm pitch 64-pin WFLGA (PWLG0064KA-A) 5 × 5 mm, 0.5 mm pitch 64-pin HWQFN (PWQN0064KC-A) 9 × 9 mm, 0.5 mm pitch 64-pin LFQFP (PLQP0064KB-C) 10 × 10 mm, 0.5 mm pitch 48-pin HWQFN (PWQN0048KB-A) 7 × 7 mm, 0.5 mm pitch 48-pin LFQFP (PLQP0048KB-B) 7 × 7 mm, 0.5 mm pitch
Debugging interfaces		FINE interface

Table 1.6 List of Pins and Pin Functions (100-Pin TFLGA) (3/3)

Pin No.	Power Supply, Clock, System Control	I/O Port	External Bus	Timers (MTU, TPU, TMR, RTC, CMT, POE, CAC)	Communications (SCI, RSPI, RIIC, RSCAN, USB, SSI)	Memory Interface (SDHI)	Touch sensing	Others
J6	VCC_USB*1	PH3*1		TMCI0*1				
J7		P50	WR0#/WR#				TS20	
J8		PC4	A20/CS3#	MTIOC3D/MTCLKC/TMCI1/ POE0#	SCK5/CTS8#/RTS8#/ SS8#/SSLA0	SDHI_D1	TSCAP	
J9		PC0	A16	MTIOC3C/TCLKC	CTS5#/RTS5#/SS5#/ SSLA1		TS35	
J10		PC1	A17	MTIOC3A/TCLKD	SCK5/SSLA2		TS33	
K1		P23		MTIOC3D/MTCLKD/ TIOCD3	CTS0#/RTS0#/SS0#/ SSISCK0		TS6	
K2		P22		MTIOC3B/MTCLKC/TMO0/ TIOCC3	SCK0/ USB0_OVRCURB/ AUDIO_MCLK		TS7	
K3		P20		MTIOC1A/TMRI0/TIOCB3	TXD0/SMOSI0/SSDA0/ USB0_ID/SSIRXD0		TS9	
K4		P14		MTIOC3A/MTCLKA/TMRI2/ TIOCB5/TCLKA	CTS1#/RTS1#/SS1#/ CTXD0/USB0_OVRCURA		TS13	IRQ4/ CVREFB2
K5		PH2*1		TMRI0*1	USB0_DM*1			IRQ1*1
K6		PH1*1		TMO0*1	USB0_DP*1			IRQ0*1
K7		P51	WR1#/BC1#/ WAIT#				TS19	
K8		PC5	A21/CS2#/ WAIT#	MTIOC3B/MTCLKD/TMRI2	SCK8/RSPCKA		TS23	
K9		PC3	A19	MTIOC4D/TCLKB	TXD5/SMOSI5/SSDA5/ IRTXD5	SDHI_D0	TS27	
K10		PC2	A18	MTIOC4B/TCLKA	RXD5/SMISO5/SSCL5/ SSLA3/ IRRXD5	SDHI_D3	TS30	

Note 1. RX230: PH0/CACREF, PH1/IRQ0/TMO0, PH2/IRQ1/TMRI0, PH3/TMCI0
RX231: VSS_USB, USB0_DP, USB0_DM, VCC_USB

3. Address Space

3.1 Address Space

This LSI has a 4-Gbyte address space, consisting of the range of addresses from 0000 0000h to FFFF FFFFh. That is, linear access to an address space of up to 4 Gbytes is possible, and this contains both program and data areas.
Figure 3.1 shows the memory maps in the respective operating modes. Accessible areas will differ according to the operating mode and states of control bits.

Table 4.1 List of I/O Registers (Address Order) (7/33)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK ≥ PCLK	ICLK <PCLK
0008 830Dh	RIIC0	Slave Address Register U1	SARU1	8	8	2 or 3 PCLKB	2 ICLK
0008 830Eh	RIIC0	Slave Address Register L2	SARL2	8	8	2 or 3 PCLKB	2 ICLK
0008 830Fh	RIIC0	Slave Address Register U2	SARU2	8	8	2 or 3 PCLKB	2 ICLK
0008 8310h	RIIC0	I²C-Bus Bit Rate Low-Level Register	ICBRL	8	8	2 or 3 PCLKB	2 ICLK
0008 8311h	RIIC0	I²C-Bus Bit Rate High-Level Register	ICBRH	8	8	2 or 3 PCLKB	2 ICLK
0008 8312h	RIIC0	I²C-Bus Transmit Data Register	ICDRT	8	8	2 or 3 PCLKB	2 ICLK
0008 8313h	RIIC0	I²C-Bus Receive Data Register	ICDRR	8	8	2 or 3 PCLKB	2 ICLK
0008 8380h	RSPI0	RSPI Control Register	SPCR	8	8	2 or 3 PCLKB	2 ICLK
0008 8381h	RSPI0	RSPI Slave Select Polarity Register	SSLP	8	8	2 or 3 PCLKB	2 ICLK
0008 8382h	RSPI0	RSPI Pin Control Register	SPPCR	8	8	2 or 3 PCLKB	2 ICLK
0008 8383h	RSPI0	RSPI Status Register	SPSR	8	8	2 or 3 PCLKB	2 ICLK
0008 8384h	RSPI0	RSPI Data Register	SPDR	32	16, 32	2 or 3 PCLKB	2 ICLK
0008 8388h	RSPI0	RSPI Sequence Control Register	SPSCR	8	8	2 or 3 PCLKB	2 ICLK
0008 8389h	RSPI0	RSPI Sequence Status Register	SPSSR	8	8	2 or 3 PCLKB	2 ICLK
0008 838Ah	RSPI0	RSPI Bit Rate Register	SPBR	8	8	2 or 3 PCLKB	2 ICLK
0008 838Bh	RSPI0	RSPI Data Control Register	SPDCR	8	8	2 or 3 PCLKB	2 ICLK
0008 838Ch	RSPI0	RSPI Clock Delay Register	SPCKD	8	8	2 or 3 PCLKB	2 ICLK
0008 838Dh	RSPI0	RSPI Slave Select Negation Delay Register	SSLND	8	8	2 or 3 PCLKB	2 ICLK
0008 838Eh	RSPI0	RSPI Next-Access Delay Register	SPND	8	8	2 or 3 PCLKB	2 ICLK
0008 838Fh	RSPI0	RSPI Control Register 2	SPCR2	8	8	2 or 3 PCLKB	2 ICLK
0008 8390h	RSPI0	RSPI Command Register 0	SPCMD0	16	16	2 or 3 PCLKB	2 ICLK
0008 8392h	RSPI0	RSPI Command Register 1	SPCMD1	16	16	2 or 3 PCLKB	2 ICLK
0008 8394h	RSPI0	RSPI Command Register 2	SPCMD2	16	16	2 or 3 PCLKB	2 ICLK
0008 8396h	RSPI0	RSPI Command Register 3	SPCMD3	16	16	2 or 3 PCLKB	2 ICLK
0008 8398h	RSPI0	RSPI Command Register 4	SPCMD4	16	16	2 or 3 PCLKB	2 ICLK
0008 839Ah	RSPI0	RSPI Command Register 5	SPCMD5	16	16	2 or 3 PCLKB	2 ICLK
0008 839Ch	RSPI0	RSPI Command Register 6	SPCMD6	16	16	2 or 3 PCLKB	2 ICLK
0008 839Eh	RSPI0	RSPI Command Register 7	SPCMD7	16	16	2 or 3 PCLKB	2 ICLK
0008 8410h	IRDA	IrDA Control Register	IRCR	8	8	2 or 3 PCLKB	2 ICLK
0008 8900h	POE	Input Level Control/Status Register 1	ICSR1	16	8, 16	2 or 3 PCLKB	2 ICLK
0008 8902h	POE	Output Level Control/Status Register 1	OCSR1	16	8, 16	2 or 3 PCLKB	2 ICLK
0008 8908h	POE	Input Level Control/Status Register 2	ICSR2	16	8, 16	2 or 3 PCLKB	2 ICLK
0008 890Ah	POE	Software Port Output Enable Register	SPOER	8	8	2 or 3 PCLKB	2 ICLK
0008 890Bh	POE	Port Output Enable Control Register 1	POECR1	8	8	2 or 3 PCLKB	2 ICLK
0008 890Ch	POE	Port Output Enable Control Register 2	POECR2	8	8	2 or 3 PCLKB	2 ICLK
0008 890Eh	POE	Input Level Control/Status Register 3	ICSR3	16	8, 16	2 or 3 PCLKB	2 ICLK
0008 9000h	S12AD	A/D Control Register	ADCSR	16	16	2 or 3 PCLKB	2 ICLK
0008 9004h	S12AD	A/D Channel Select Register A0	ADANSA0	16	16	2 or 3 PCLKB	2 ICLK
0008 9006h	S12AD	A/D Channel Select Register A1	ADANSA1	16	16	2 or 3 PCLKB	2 ICLK
0008 9008h	S12AD	A/D-Converted Value Addition/Average Function Select Register 0	ADADS0	16	16	2 or 3 PCLKB	2 ICLK
0008 900Ah	S12AD	A/D-Converted Value Addition/Average Function Select Register 1	ADADS1	16	16	2 or 3 PCLKB	2 ICLK
0008 900Ch	S12AD	A/D-Converted Value Addition/Average Count Select Register	ADADC	8	8	2 or 3 PCLKB	2 ICLK
0008 900Eh	S12AD	A/D Control Extended Register	ADCER	16	16	2 or 3 PCLKB	2 ICLK
0008 9010h	S12AD	A/D Conversion Start Trigger Select Register	ADSTRGR	16	16	2 or 3 PCLKB	2 ICLK
0008 9012h	S12AD	A/D Conversion Extended Input Control Register	ADEXICR	16	16	2 or 3 PCLKB	2 ICLK
0008 9014h	S12AD	A/D Channel Select Register B0	ADANSB0	16	16	2 or 3 PCLKB	2 ICLK
0008 9016h	S12AD	A/D Channel Select Register B1	ADANSB1	16	16	2 or 3 PCLKB	2 ICLK
0008 9018h	S12AD	A/D Data Duplication Register	ADDBLDR	16	16	2 or 3 PCLKB	2 ICLK
0008 901Ah	S12AD	A/D Temperature Sensor Data Register	ADTSDR	16	16	2 or 3 PCLKB	2 ICLK
0008 901Ch	S12AD	A/D Internal Reference Voltage Data Register	ADOCDR	16	16	2 or 3 PCLKB	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (10/33)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK ≥ PCLK	ICLK <PCLK
0008 A012h	SCI0	Modulation Duty Register	MDDR	8	8	2 or 3 PCLKB	2 ICLK
0008 A020h	SCI1	Serial Mode Register	SMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A021h	SCI1	Bit Rate Register	BRR	8	8	2 or 3 PCLKB	2 ICLK
0008 A022h	SCI1	Serial Control Register	SCR	8	8	2 or 3 PCLKB	2 ICLK
0008 A023h	SCI1	Transmit Data Register	TDR	8	8	2 or 3 PCLKB	2 ICLK
0008 A024h	SCI1	Serial Status Register	SSR	8	8	2 or 3 PCLKB	2 ICLK
0008 A025h	SCI1	Receive Data Register	RDR	8	8	2 or 3 PCLKB	2 ICLK
0008 A026h	SCI1	Smart Card Mode Register	SCMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A027h	SCI1	Serial Extended Mode Register	SEMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A028h	SCI1	Noise Filter Setting Register	SNFR	8	8	2 or 3 PCLKB	2 ICLK
0008 A029h	SCI1	I^2C Mode Register 1	SIMR1	8	8	2 or 3 PCLKB	2 ICLK
0008 A02Ah	SCI1	I^2C Mode Register 2	SIMR2	8	8	2 or 3 PCLKB	2 ICLK
0008 A02Bh	SCI1	I^2C Mode Register 3	SIMR3	8	8	2 or 3 PCLKB	2 ICLK
0008 A02Ch	SCI1	I^2C Status Register	SISR	8	8	2 or 3 PCLKB	2 ICLK
0008 A02Dh	SCI1	SPI Mode Register	SPMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A02Eh	SCI1	Transmit Data Register HL	TDRHL	16	16	4 or 5 PCLKB	2 ICLK
0008 A02Eh	SCI1	Transmit Data Register H	TDRH	8	8	2 or 3 PCLKB	2 ICLK
0008 A02Fh	SCI1	Transmit Data Register L	TDRL	8	8	2 or 3 PCLKB	2 ICLK
0008 A030h	SCI1	Receive Data Register HL	RDRHL	16	16	4 or 5 PCLKB	2 ICLK
0008 A030h	SCI1	Receive Data Register H	RDRH	8	8	2 or 3 PCLKB	2 ICLK
0008 A031h	SCI1	Receive Data Register L	RDRL	8	8	2 or 3 PCLKB	2 ICLK
0008 A032h	SCI1	Modulation Duty Register	MDDR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A0h	SCI5	Serial Mode Register	SMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A1h	SCI5	Bit Rate Register	BRR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A2h	SCI5	Serial Control Register	SCR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A3h	SCI5	Transmit Data Register	TDR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A4h	SCI5	Serial Status Register	SSR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A5h	SCI5	Receive Data Register	RDR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A6h	SCI5	Smart Card Mode Register	SCMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A7h	SCI5	Serial Extended Mode Register	SEMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A8h	SCI5	Noise Filter Setting Register	SNFR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A9h	SCI5	I^2C Mode Register 1	SIMR1	8	8	2 or 3 PCLKB	2 ICLK
0008 A0AAh	SCI5	I^2C Mode Register 2	SIMR2	8	8	2 or 3 PCLKB	2 ICLK
0008 A0ABh	SCI5	I^2C Mode Register 3	SIMR3	8	8	2 or 3 PCLKB	2 ICLK
0008 A0ACh	SCI5	I^2C Status Register	SISR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0ADh	SCI5	SPI Mode Register	SPMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0AEh	SCI5	Transmit Data Register HL	TDRHL	16	16	4 or 5 PCLKB	2 ICLK
0008 A0AEh	SCI5	Transmit Data Register H	TDRH	8	8	2 or 3 PCLKB	2 ICLK
0008 A0AFh	SCI5	Transmit Data Register L	TDRL	8	8	2 or 3 PCLKB	2 ICLK
0008 A0B0h	SCI5	Receive Data Register HL	RDRHL	16	16	4 or 5 PCLKB	2 ICLK
0008 A0B0h	SCI5	Receive Data Register H	RDRH	8	8	2 or 3 PCLKB	2 ICLK
0008 A0B1h	SCI5	Receive Data Register L	RDRL	8	8	2 or 3 PCLKB	2 ICLK
0008 A0B2h	SCI5	Modulation Duty Register	MDDR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0C0h	SCI6	Serial Mode Register	SMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0C1h	SCI6	Bit Rate Register	BRR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0C2h	SCI6	Serial Control Register	SCR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0C3h	SCI6	Transmit Data Register	TDR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0C4h	SCI6	Serial Status Register	SSR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0C5h	SCI6	Receive Data Register	RDR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0C6h	SCI6	Smart Card Mode Register	SCMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0C7h	SCI6	Serial Extended Mode Register	SEMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0C8h	SCI6	Noise Filter Setting Register	SNFR	8	8	2 or 3 PCLKB	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (19/33)

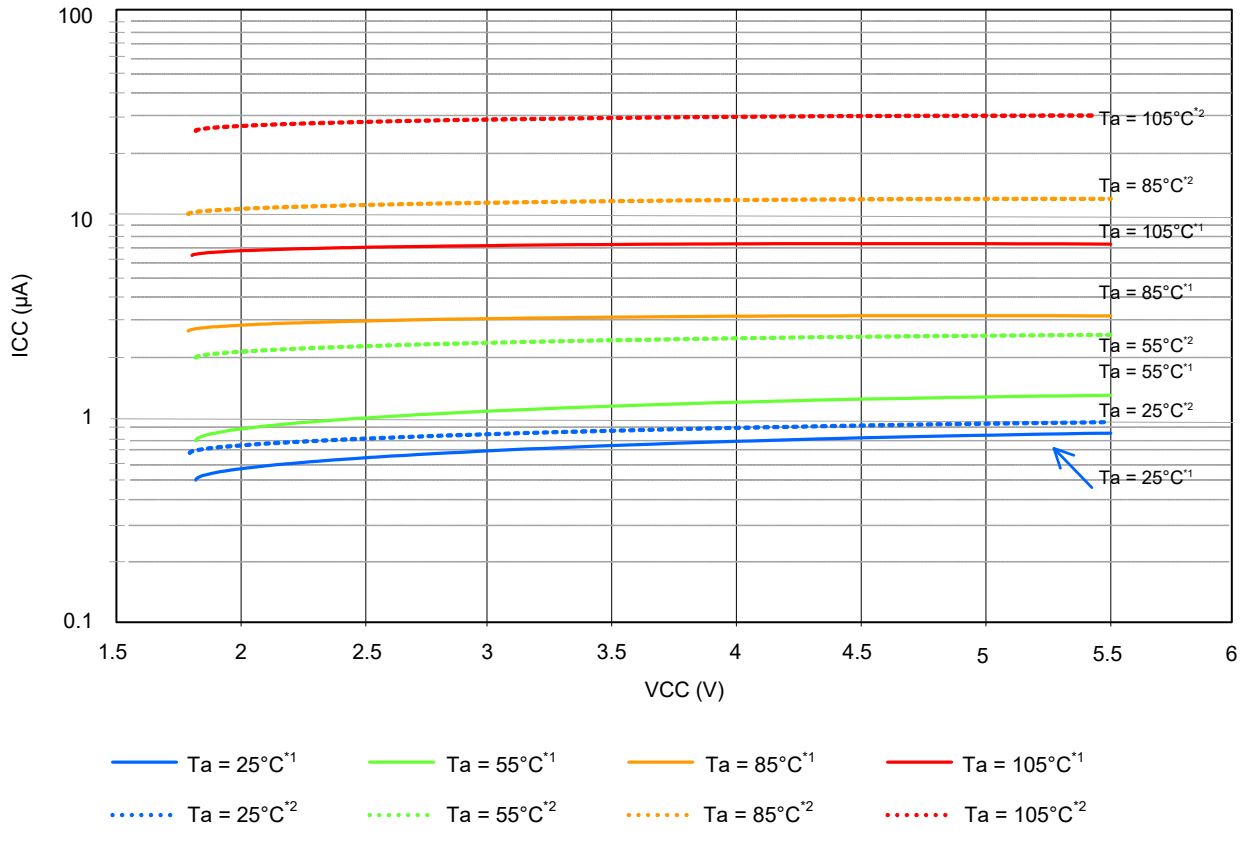
Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK ≥ PCLK	ICLK <PCLK
0008 C1B3h	MPC	PE3 Pin Function Control Register	PE3PFS	8	8	2 or 3 PCLKB	2 ICLK
0008 C1B4h	MPC	PE4 Pin Function Control Register	PE4PFS	8	8	2 or 3 PCLKB	2 ICLK
0008 C1B5h	MPC	PE5 Pin Function Control Register	PE5PFS	8	8	2 or 3 PCLKB	2 ICLK
0008 C1B6h	MPC	PE6 Pin Function Control Register	PE6PFS	8	8	2 or 3 PCLKB	2 ICLK
0008 C1B7h	MPC	PE7 Pin Function Control Register	PE7PFS	8	8	2 or 3 PCLKB	2 ICLK
0008 C1C8h	MPC	PH0 Pin Function Control Register	PH0PFS	8	8	2 or 3 PCLKB	2 ICLK
0008 C1C9h	MPC	PH1 Pin Function Control Register	PH1PFS	8	8	2 or 3 PCLKB	2 ICLK
0008 C1CAh	MPC	PH2 Pin Function Control Register	PH2PFS	8	8	2 or 3 PCLKB	2 ICLK
0008 C1CBh	MPC	PH3 Pin Function Control Register	PH3PFS	8	8	2 or 3 PCLKB	2 ICLK
0008 C1D3h	MPC	PJ3 Pin Function Control Register	PJ3PFS	8	8	2 or 3 PCLKB	2 ICLK
0008 C290h	SYSTEM	Reset Status Register 0	RSTSR0	8	8	4 or 5 PCLKB	2 or 3 ICLK
0008 C291h	SYSTEM	Reset Status Register 1	RSTSR1	8	8	4 or 5 PCLKB	2 or 3 ICLK
0008 C293h	SYSTEM	Main Clock Oscillator Forced Oscillation Control Register	MOFCR	8	8	4 or 5 PCLKB	2 or 3 ICLK
0008 C297h	SYSTEM	Voltage Monitoring Circuit Control Register	LVCMPCR	8	8	4 or 5 PCLKB	2 or 3 ICLK
0008 C298h	SYSTEM	Voltage Detection Level Select Register	LVDLVLR	8	8	4 or 5 PCLKB	2 or 3 ICLK
0008 C29Ah	SYSTEM	Voltage Monitoring 1 Circuit Control Register 0	LVD1CR0	8	8	4 or 5 PCLKB	2 or 3 ICLK
0008 C29Bh	SYSTEM	Voltage Monitoring 2 Circuit Control Register 0	LVD2CR0	8	8	4 or 5 PCLKB	2 or 3 ICLK
0008 C29Dh	SYSTEM	VBATT Control Register	VBATTCR	8	8	4 or 5 PCLKB	2 or 3 ICLK
0008 C29Eh	SYSTEM	VBATT Status Register	VBATTSR	8	8	4 or 5 PCLKB	2 or 3 ICLK
0008 C29Fh	SYSTEM	VBATT Pin Voltage Drop Detection Interrupt Control Register	VBTLVDICR	8	8	4 or 5 PCLKB	2 or 3 ICLK
0008 C400h	RTC	64-Hz Counter	R64CNT	8	8	2 or 3 PCLKB	2 ICLK
0008 C402h	RTC	Second Counter	RSECCNT	8	8	2 or 3 PCLKB	2 ICLK
0008 C402h	RTC	Binary Counter 0	BCNT0	8	8	2 or 3 PCLKB	2 ICLK
0008 C404h	RTC	Minute Counter	RMINCNT	8	8	2 or 3 PCLKB	2 ICLK
0008 C404h	RTC	Binary Counter 1	BCNT1	8	8	2 or 3 PCLKB	2 ICLK
0008 C406h	RTC	Hour Counter	RHRCNT	8	8	2 or 3 PCLKB	2 ICLK
0008 C406h	RTC	Binary Counter 2	BCNT2	8	8	2 or 3 PCLKB	2 ICLK
0008 C408h	RTC	Day-of-Week Counter	RWKCNT	8	8	2 or 3 PCLKB	2 ICLK
0008 C408h	RTC	Binary Counter 3	BCNT3	8	8	2 or 3 PCLKB	2 ICLK
0008 C40Ah	RTC	Date Counter	RDAYCNT	8	8	2 or 3 PCLKB	2 ICLK
0008 C40Ch	RTC	Month Counter	RMONCNT	8	8	2 or 3 PCLKB	2 ICLK
0008 C40Eh	RTC	Year Counter	RYRCNT	16	16	2 or 3 PCLKB	2 ICLK
0008 C410h	RTC	Second Alarm Register	RSECAR	8	8	2 or 3 PCLKB	2 ICLK
0008 C410h	RTC	Binary Counter 0 Alarm Register	BCNT0AR	8	8	2 or 3 PCLKB	2 ICLK
0008 C412h	RTC	Minute Alarm Register	RMINAR	8	8	2 or 3 PCLKB	2 ICLK
0008 C412h	RTC	Binary Counter 1 Alarm Register	BCNT1AR	8	8	2 or 3 PCLKB	2 ICLK
0008 C414h	RTC	Hour Alarm Register	RHRAR	8	8	2 or 3 PCLKB	2 ICLK
0008 C414h	RTC	Binary Counter 2 Alarm Register	BCNT2AR	8	8	2 or 3 PCLKB	2 ICLK
0008 C416h	RTC	Day-of-Week Alarm Register	RWKAR	8	8	2 or 3 PCLKB	2 ICLK
0008 C416h	RTC	Binary Counter 3 Alarm Register	BCNT3AR	8	8	2 or 3 PCLKB	2 ICLK
0008 C418h	RTC	Date Alarm Register	RDAYAR	8	8	2 or 3 PCLKB	2 ICLK
0008 C418h	RTC	Binary Counter 0 Alarm Enable Register	BCNT0AER	8	8	2 or 3 PCLKB	2 ICLK
0008 C41Ah	RTC	Month Alarm Register	RMONAR	8	8	2 or 3 PCLKB	2 ICLK
0008 C41Ah	RTC	Binary Counter 1 Alarm Enable Register	BCNT1AER	8	8	2 or 3 PCLKB	2 ICLK
0008 C41Ch	RTC	Year Alarm Register	RYRAR	16	16	2 or 3 PCLKB	2 ICLK
0008 C41Ch	RTC	Binary Counter 2 Alarm Enable Register	BCNT2AER	16	16	2 or 3 PCLKB	2 ICLK
0008 C41Eh	RTC	Year Alarm Enable Register	RYRAREN	8	8	2 or 3 PCLKB	2 ICLK
0008 C41Eh	RTC	Binary Counter 3 Alarm Enable Register	BCNT3AER	8	8	2 or 3 PCLKB	2 ICLK
0008 C422h	RTC	RTC Control Register 1	RCR1	8	8	2 or 3 PCLKB	2 ICLK
0008 C424h	RTC	RTC Control Register 2	RCR2	8	8	2 or 3 PCLKB	2 ICLK
0008 C426h	RTC	RTC Control Register 3	RCR3	8	8	2 or 3 PCLKB	2 ICLK

Table 5.8 DC Characteristics (6)

Conditions: 1.8 V ≤ VCC= VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item			Symbol	Typ.*3	Max.	Unit	Test Conditions
Supply current*1	Software standby mode*2	T_a = 25°C	I_{CC}	0.8	3.7	μA	
		T_a = 55°C		1.2	4.3		
		T_a = 85°C		3.5	18.6		
		T_a = 105°C		7.9	45.2		
	Increment for IWDT operation			0.4	—		
	Increment for LPT operation			0.4	—		Use IWDT-Dedicated On-Chip Oscillator for clock source
	Increment for RTC operation*4			0.4	—		RCR3.RTCDV[2:0] set to low drive capacity
				1.2	—		RCR3.RTCDV[2:0] set to normal drive capacity

Note 1. Supply current values are with all output pins unloaded and all input pull-up MOSs in the off state.
Note 2. The IWDT, LVD, and CMPB are stopped.
Note 3. When VCC is 3.3 V.
Note 4. This increment includes the oscillation circuit.



Note 1. Indicates the average of the typical samples through actual measurement during product evaluation.
Note 2. Indicates the average of the upper-limit samples through actual measurement during product evaluation.

Figure 5.4 Voltage Dependency in Software Standby Mode (Reference Data)

Table 5.11 DC Characteristics (9)

Conditions: 1.8 V ≤ VCC = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Symbol	Min.	Typ.*7	Max.	Unit	Test Conditions
Analog power supply current	During A/D conversion (at high-speed conversion)	I_{AVCC}	—	0.7	1.7	mA	
	During A/D conversion (in low-current mode)		—	0.6	1.0		
	During D/A conversion (per channel)*1		—	0.4	0.8		
	Waiting for A/D and D/A conversion (all units)		—	—	0.4	μA	
Reference power supply current	During A/D conversion (at high-speed conversion)	I_{REFH0}	—	25	150	μA	
	Waiting for A/D conversion (all units)		—	—	60	nA	
	During D/A conversion (per channel)	I_{REFH}	—	50	100	μA	
	Waiting for D/A conversion (all units)		—	—	100	nA	
LVD1, 2	per channel	I_{LVD}	—	0.15	—	μA	
Temperature sensor*6	—	I_{TEMP}	—	75	—	μA	
Comparator B operating current*6	Window mode	I_{CMP}*5	—	12.5	28.6	μA	
	Comparator high-speed mode (per channel)		—	3.2	16.2	μA	
	Comparator low-speed mode (per channel)		—	1.7	4.4	μA	
CTSU operating current	When sleep mode Base clock frequency: 2MHz Pin capacitance: 50pF	I_{CTSU}	—	150	—	μA	
USB operating current*4	During USB communication operation under the following settings and conditions • Host controller operation is set to full-speed mode Bulk OUT transfer (64 bytes) × 1, bulk IN transfer (64 bytes) × 1 • Connect peripheral devices via a 1-meter USB cable from the USB port.	I_{USBH}*2	—	4.3 (VCC) 0.9 (VCC_USB)	—	mA	
	During USB communication operation under the following settings and conditions • Function controller operation is set to full-speed mode Bulk OUT transfer (64 bytes) × 1, bulk IN transfer (64 bytes) × 1 • Connect the host device via a 1-meter USB cable from the USB port.	I_{USBF}*2	—	3.6 (VCC) 1.1 (VCC_USB)	—	mA	
	During suspended state under the following setting and conditions • Function controller operation is set to full-speed mode (pull up the USB0_DP pin) • Software standby mode • Connect the host device via a 1-meter USB cable from the USB port.	I_{SUSP}*3	—	0.35 (VCC) 170 (VCC_USB)	—	μA	

Note 1. The value of the D/A converter is the value of the power supply current including the reference current.
Note 2. Current consumed only by the USB module.
Note 3. Includes the current supplied from the pull-up resistor of the USB0_DP pin to the pull-down resistor of the host device, in addition to the current consumed by this MCU during the suspended state.
Note 4. Current consumed by the power supplies (VCC and VCC_USB).
Note 5. Current consumed only by the comparator B module.
Note 6. Current consumed by the power supply (VCC).
Note 7. When VCC = AVCC0 = VCC_USB = 3.3 V.

Table 5.12 DC Characteristics (10)

Conditions: 1.8 V ≤ VCC = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
RAM standby voltage	V_{RAM}	1.8	—	—	V	

5.2.3 Normal I/O Pin Output Characteristics (3)

Figure 5.18 to Figure 5.21 show the characteristics of the RIIC output pin.

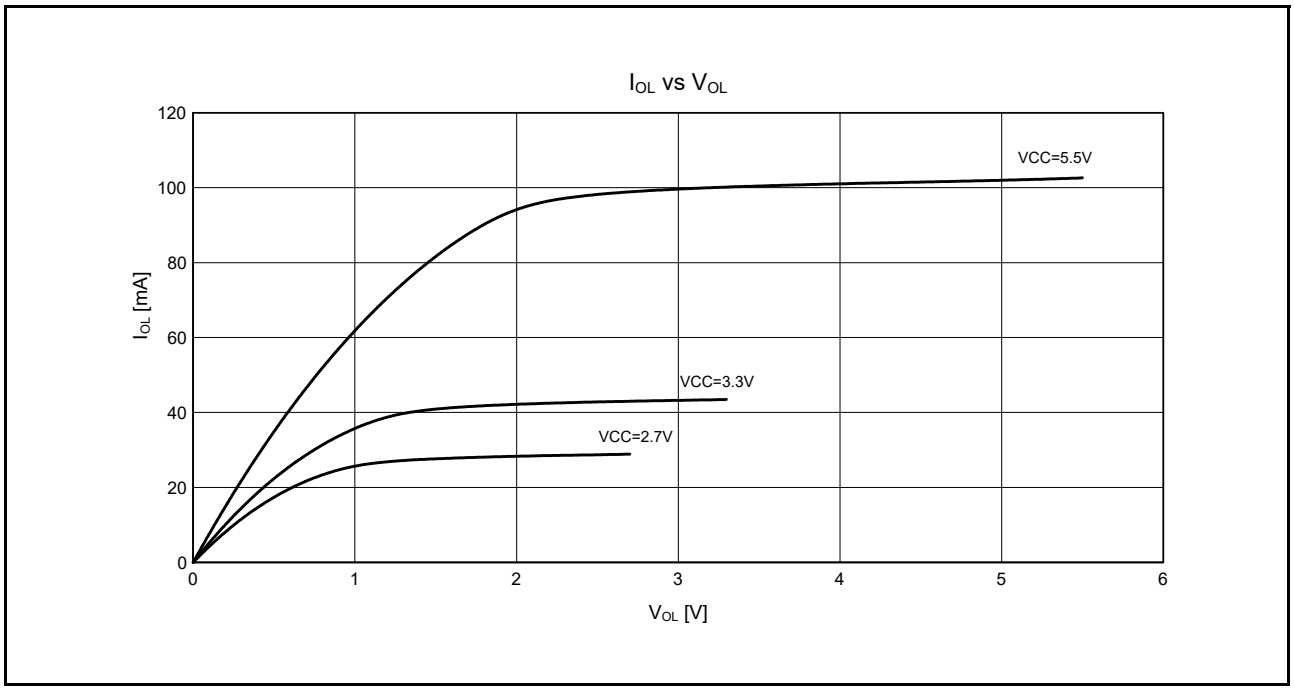


Figure 5.18 V_{OL} and I_{OL} Voltage Characteristics of RIIC Output Pin at T_a = 25°C (Reference Data)

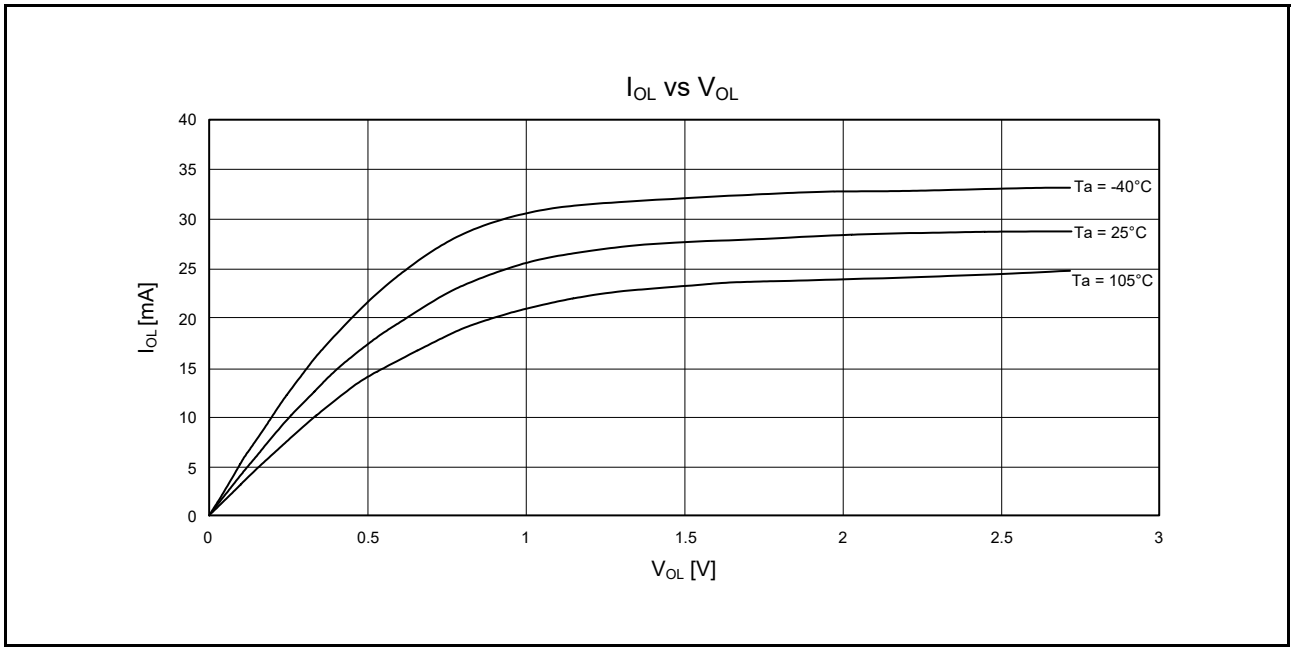


Figure 5.19 V_{OL} and I_{OL} Temperature Characteristics of RIIC Output Pin at VCC = 2.7 V (Reference Data)

Table 5.26 Clock Timing

Conditions: 1.8 V ≤ VCC = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VREFL0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
EXTAL external clock input cycle time		t_{Xcyc}	50	—	—	ns	Figure 5.23
EXTAL external clock input high pulse width		t_{XH}	20	—	—	ns	
EXTAL external clock input low pulse width		t_{XL}	20	—	—	ns	
EXTAL external clock rise time		t_{Xr}	—	—	5	ns	
EXTAL external clock fall time		t_{Xf}	—	—	5	ns	
EXTAL external clock input wait time*1		t_{XWT}	0.5	—	—	μs	
Main clock oscillator oscillation frequency*2	2.4 ≤ VCC ≤ 5.5	f_{MAIN}	1	—	20	MHz	
	1.8 ≤ VCC < 2.4		1	—	8		
Main clock oscillation stabilization time (crystal)*2		$t_{MAINOSC}$	—	3	—	ms	Figure 5.24
Main clock oscillation stabilization time (ceramic resonator)*2		$t_{MAINOSC}$	—	50	—	μs	
LOCO clock oscillation frequency		f_{LOCO}	3.44	4.0	4.56	MHz	
LOCO clock oscillation stabilization time		t_{LOCO}	—	—	0.5	μs	Figure 5.25
IWDT-dedicated clock oscillation frequency		f_{ILOCO}	12.75	15	17.25	kHz	
IWDT-dedicated clock oscillation stabilization time		t_{ILOCO}	—	—	50	μs	Figure 5.26
HOCO clock oscillation frequency		f_{HOCO} (32 MHz)	31.52	32	32.48	MHz	T_a = –40 to + 85°C
			31.68	32	32.32		T_a = 0 to + 55°C
			31.36	32	32.64		T_a = –40 to +105°C
		f_{HOCO} (54 MHz)	53.19	54	54.81	MHz	T_a = –40 to + 85°C
			53.46	54	54.54		T_a = 0 to + 55°C
			52.92	54	55.08		T_a = –40 to +105°C
HOCO clock oscillation stabilization time		t_{HOCO}	—	—	30	μs	Figure 5.28
PLL input frequency*3		f_{PLLIN}	4	—	12.5	MHz	
PLL circuit oscillation frequency*3		f_{PLL}	24	—	54	MHz	
PLL clock oscillation stabilization time		t_{PLL}	—	—	50	μs	Figure 5.29
PLL free-running oscillation frequency		f_{PLLFR}	—	8	—	MHz	
USBPLL input frequency*5		f_{PLLIN}	—	6, 8*6	—	MHz	
USBPLL circuit oscillation frequency*5		f_{PLL}	—	48*6	—	MHz	
USBPLL clock oscillation stabilization time		t_{PLL}	—	—	50	μs	Figure 5.29
Sub-clock oscillator oscillation frequency*7		f_{SUB}	—	32.768	—	kHz	
Sub-clock oscillation stabilization time*4		t_{SUBOSC}	—	0.5	—	s	Figure 5.30

Note 1. Time until the clock can be used after the main clock oscillator stop bit (MOSCCR.MOSTP) is set to 0 (operating).

Note 2. Reference values when an 8-MHz resonator is used.
When specifying the main clock oscillator stabilization time, set the MOSCWTCR register with a stabilization time value that is equal to or greater than the resonator-manufacturer-recommended value.
After the MOSCCR.MOSTP bit is changed to enable the main clock oscillator, confirm that the OSCOVFSR.MOOVF flag has become 1, and then start using the main clock.

Note 3. The VCC range should be 2.4 to 5.5 V when the PLL is used.

Note 4. Reference values when a 32.768-kHz resonator is used.
After the setting of the SOSCCR.SOSTP bit or RCR3.RTCEN bit is changed to operate the sub-clock oscillator, only start using the sub-clock after the sub-clock oscillation stabilization wait time that is equal to or greater than the oscillator-manufacturer-recommended value has elapsed.

Note 5. The VCC range should be 3.0 to 5.5 V when the USBPLL is used.

Note 6. The input frequency can be set to 6 or 8 MHz and the oscillation frequency can be set to 48 MHz only.

Note 7. Only 32.768 kHz can be used.

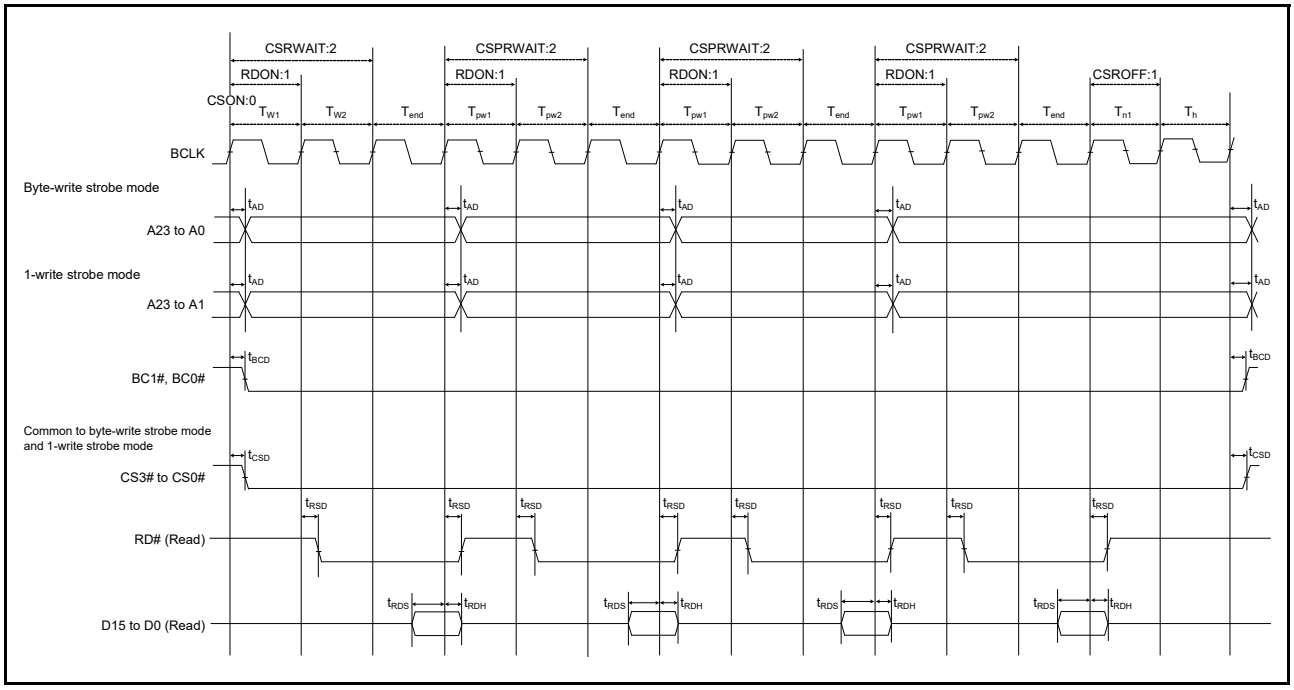
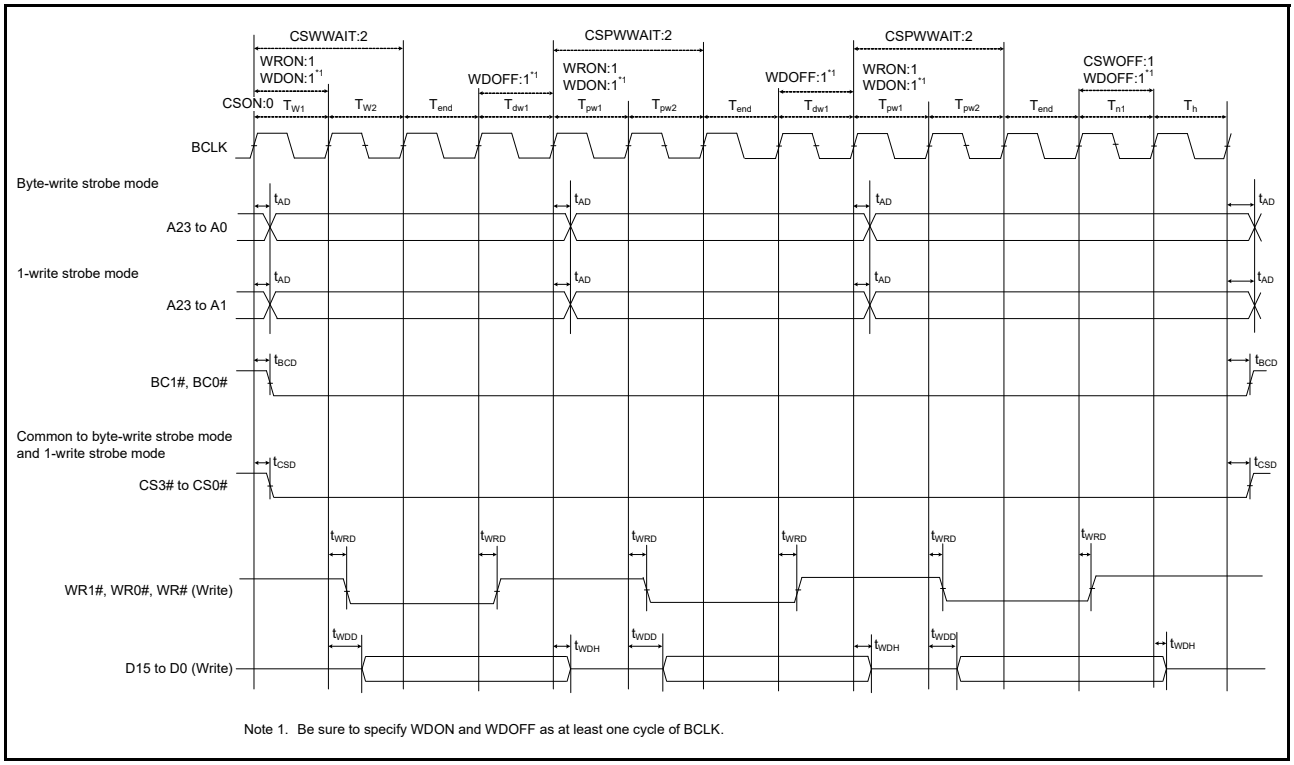


Figure 5.40 External Bus Timing/Page Read Cycle (Bus Clock Synchronization)



Note 1. Be sure to specify WDON and WDOFF as at least one cycle of BCLK.

Figure 5.41 External Bus Timing/Page Write Cycle (Bus Clock Synchronization)

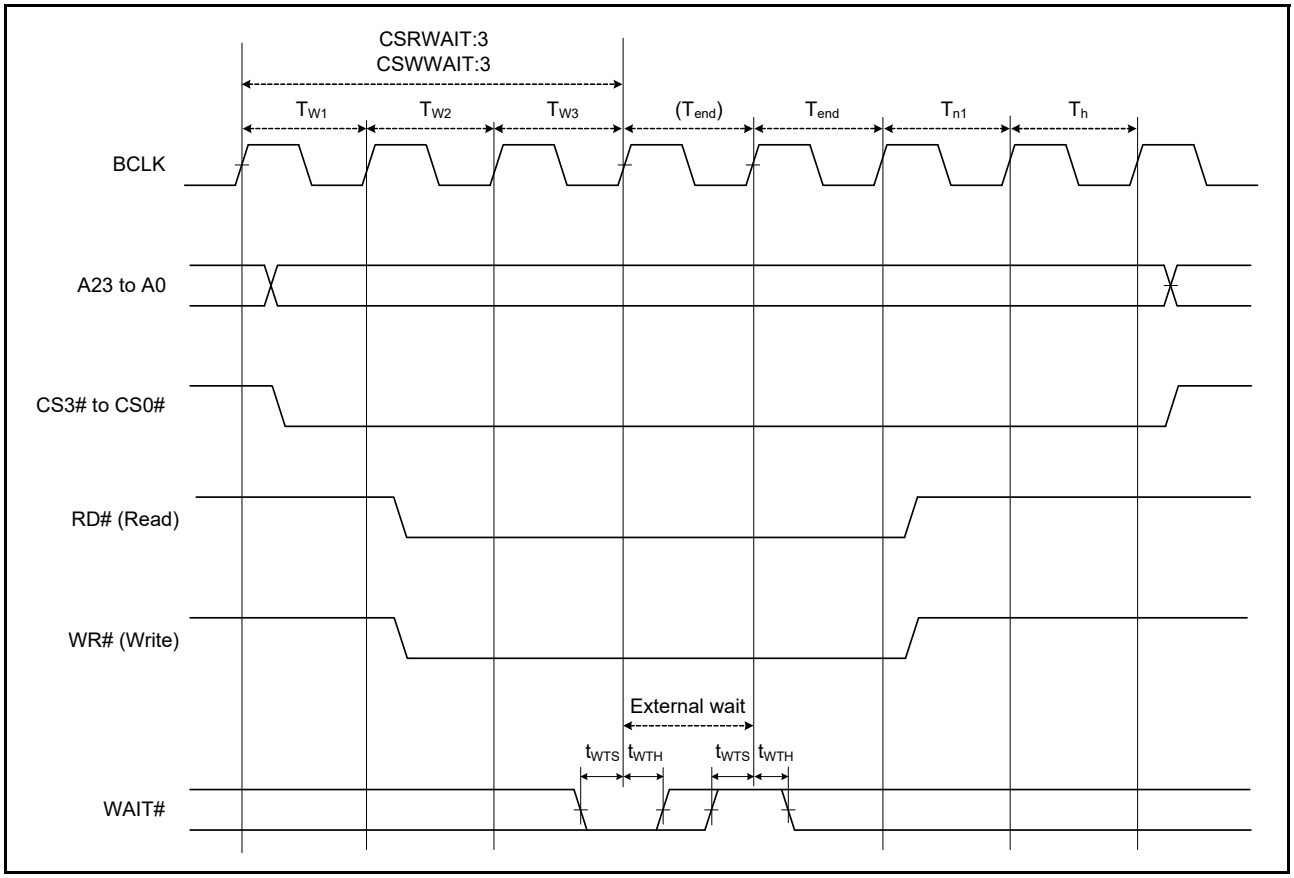


Figure 5.42 External Bus Timing/External Wait Control

Table 5.39 Timing of On-Chip Peripheral Modules (2)

Conditions: 1.8 V ≤ VCC = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C, C = 30 pF, when high-drive output is selected by the drive capacity control register

Item				Symbol	Min.	Max.	Unit	Test Conditions
RSPI	RSPCK clock cycle	Master		t_{SPcyc}	2	4096	t_{Pcyc}*1	Figure 5.54
		Slave			8	4096		
	RSPCK clock high pulse width	Master		t_{SPCKWH}	$(t_{SPcyc} - t_{SPCKr} - t_{SPCKf})/2 - 3$	—	ns	
		Slave			$(t_{SPcyc} - t_{SPCKr} - t_{SPCKf})/2$	—		
	RSPCK clock low pulse width	Master		t_{SPCKWL}	$(t_{SPcyc} - t_{SPCKr} - t_{SPCKf})/2 - 3$	—	ns	
		Slave			$(t_{SPcyc} - t_{SPCKr} - t_{SPCKf})/2$	—		
	RSPCK clock rise/fall time	Output	2.7 V or above	t_{SPCKr}, t_{SPCKf}	—	10	ns	
			1.8 V or above		—	15		
		Input			—	1	µs	
	Data input setup time	Master	2.7 V or above	t_{SU}	10	—	ns	Figure 5.55 to Figure 5.58
			1.8 V or above		30	—		
		Slave			$25 - t_{Pcyc}$	—		
	Data input hold time	Master	RSPCK set to a division ratio other than PCLKB divided by 2	t_H	t_{Pcyc}	—	ns	
			RSPCK set to PCLKB divided by 2	t_{HF}	0	—		
		Slave		t_H	$20 + 2 \times t_{Pcyc}$	—		
	SSL setup time	Master		t_{LEAD}	$-30 + N^{*2} \times t_{SPcyc}$	—	ns	
		Slave			2	—	t_{Pcyc}	
	SSL hold time	Master		t_{LAG}	$-30 + N^{*3} \times t_{SPcyc}$	—	ns	
		Slave			2	—	t_{Pcyc}	
	Data output delay time	Master	2.7 V or above	t_{OD}	—	14	ns	
			1.8 V or above		—	30		
		Slave	2.7 V or above		—	$3 \times t_{Pcyc} + 65$		
			1.8 V or above		—	$3 \times t_{Pcyc} + 105$		
	Data output hold time	Master		t_{OH}	0	—	ns	
		Slave			0	—		
	Successive transmission delay time	Master		t_{TD}	$t_{SPcyc} + 2 \times t_{Pcyc}$	$8 \times t_{SPcyc} + 2 \times t_{Pcyc}$	ns	
		Slave			$4 \times t_{Pcyc}$	—		
	MOSI and MISO rise/fall time	Output	2.7 V or above	t_{Dr}, t_{Df}	—	10	ns	
			1.8 V or above		—	15		
		Input			—	1	µs	
	SSL rise/fall time	Output	2.7 V or above	t_{SSLr}, t_{SSLf}	—	10	ns	
			1.8 V or above		—	15	ns	
		Input			—	1	µs	
	Slave access time		2.7 V or above	t_{SA}	—	6	t_{Pcyc}	Figure 5.57, Figure 5.58
			1.8 V or above		—	7		
	Slave output release time		2.7 V or above	t_{REL}	—	5	t_{Pcyc}	
			1.8 V or above		—	6		

Note 1. t_{Pcyc}: PCLK cycle
Note 2. N: An integer from 1 to 8 that can be set by the RSPI clock delay register (SPCKD)
Note 3. N: An integer from 1 to 8 that can be set by the RSPI slave select negation delay register (SSLND)

Table 5.42 Timing of On-Chip Peripheral Modules (5)

Conditions: 2.7 V ≤ VCC = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V, fPCLKB ≤ 32 MHz,
T_a = –40 to +105°C

Item		Symbol	Min.*1	Max.	Unit	Test Conditions
Simple I²C (Standard mode)	SDA rise time	t_{Sr}	—	1000	ns	Figure 5.59
	SDA fall time	t_{Sf}	—	300	ns	
	SDA spike pulse removal time	t_{SP}	0	4 × t_{Pcyc}	ns	
	Data setup time	t_{SDAS}	250	—	ns	
	Data hold time	t_{SDAH}	0	—	ns	
	SCL, SDA capacitive load	C_b	—	400	pF	
Simple I²C (Fast mode)	SDA rise time	t_{Sr}	—	300	ns	Figure 5.59
	SDA fall time	t_{Sf}	—	300	ns	
	SDA spike pulse removal time	t_{SP}	0	4 × t_{Pcyc}	ns	
	Data setup time	t_{SDAS}	100	—	ns	
	Data hold time	t_{SDAH}	0	—	ns	
	SCL, SDA capacitive load	C_b	—	400	pF	

Note: t_{Pcyc}: PCLK cycle
Note 1. C_b is the total capacitance of the bus lines.

Table 5.43 Timing of On-Chip Peripheral Modules (6)

Conditions: 1.8 V ≤ VCC = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V, fPCLKB ≤ 32 MHz,
T_a = –40 to +105°C

Item			Symbol	Min.	Max.	Unit	Test Conditions
SSI	AUDIO_MCLK input frequency	2.7 V or above	t_{AUDIO}	1	25	MHz	
		1.8 V or above		1	4		
	Output clock cycle		t_O	250	—	ns	Figure 5.60
	Input clock cycle		t_I	250	—	ns	
	Clock high level		t_{HC}	0.4	0.6	to, ti	
	Clock low level		t_{LC}	0.4	0.6	to, ti	
	Clock rise time		t_{RC}	—	20	ns	
	Data delay time	2.7 V or above	t_{DTR}	—	65	ns	Figure 5.61 Figure 5.62
		1.8 V or above		—	105		
	Setup time	2.7 V or above	t_{SR}	65	—	ns	
		1.8 V or above		90	—		
	Hold time		t_{HTR}	40	—	ns	
	WS changing edge SSIDATA output delay		t_{DTRW}	—	105	ns	Figure 5.63

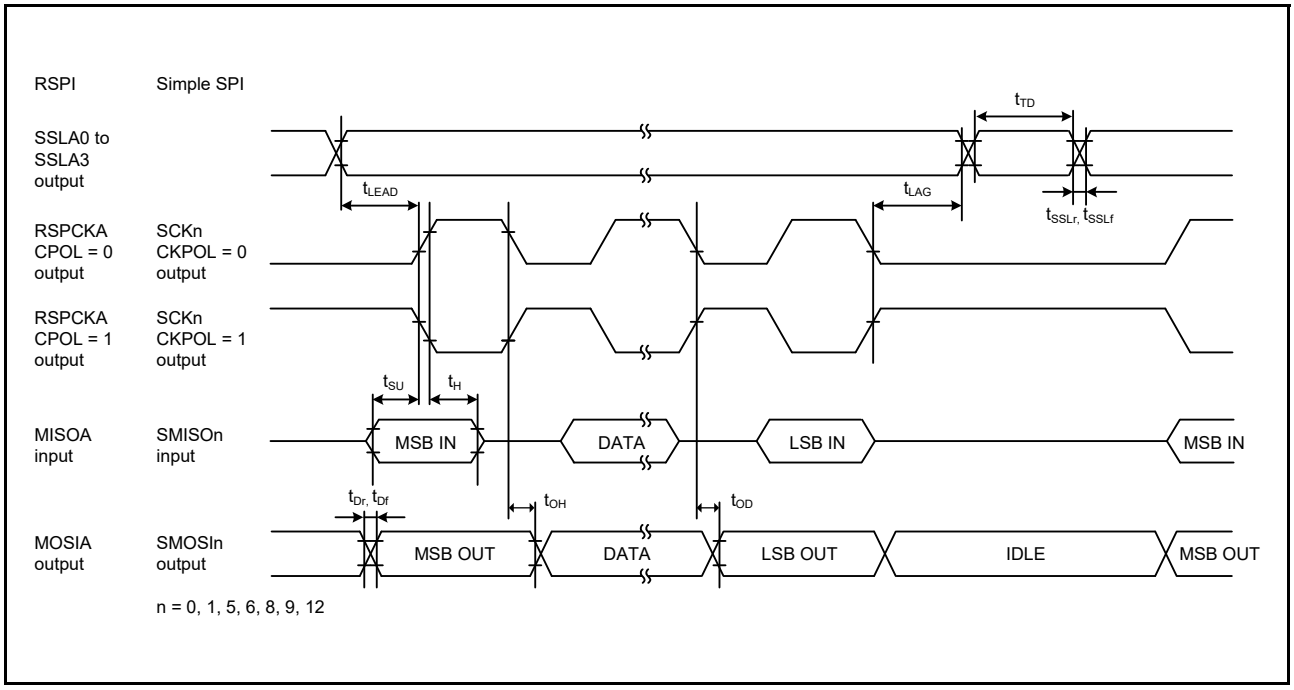


Figure 5.55 RSPI Timing (Master, CPHA = 0) and Simple SPI Clock Timing (Master, CKPH = 1)

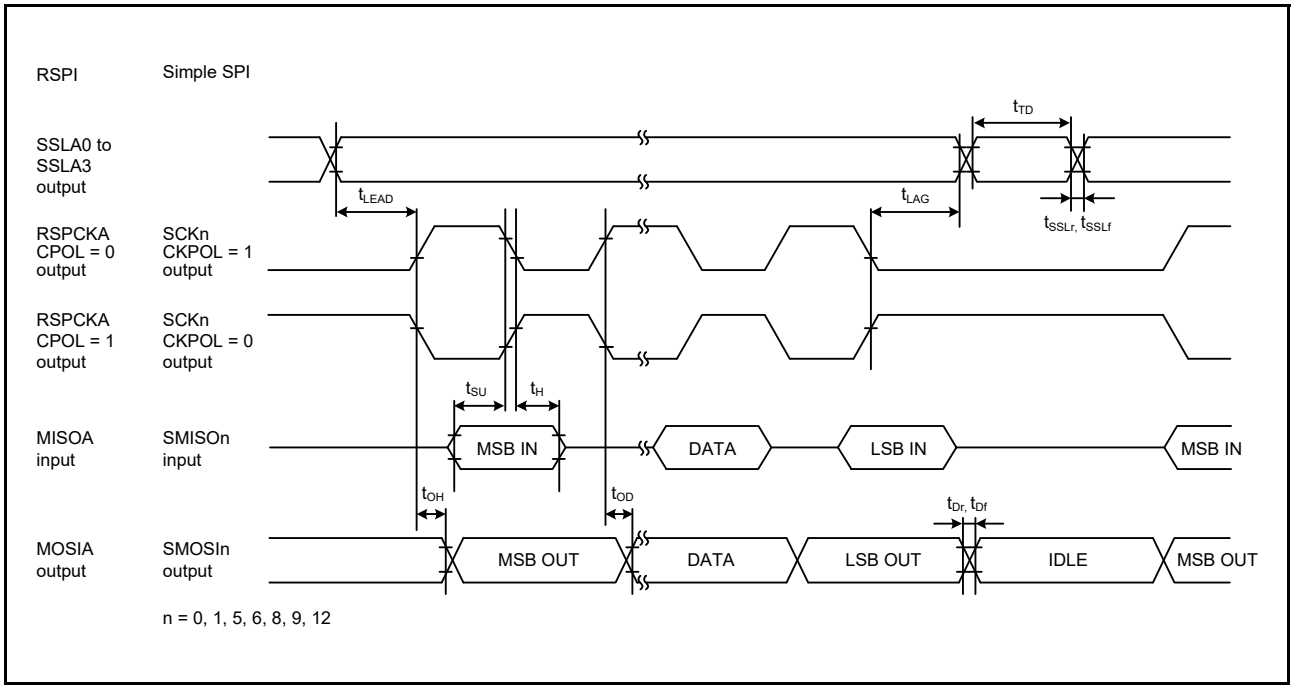


Figure 5.56 RSPI Timing (Master, CPHA = 1) and Simple SPI Clock Timing (Master, CKPH = 0)

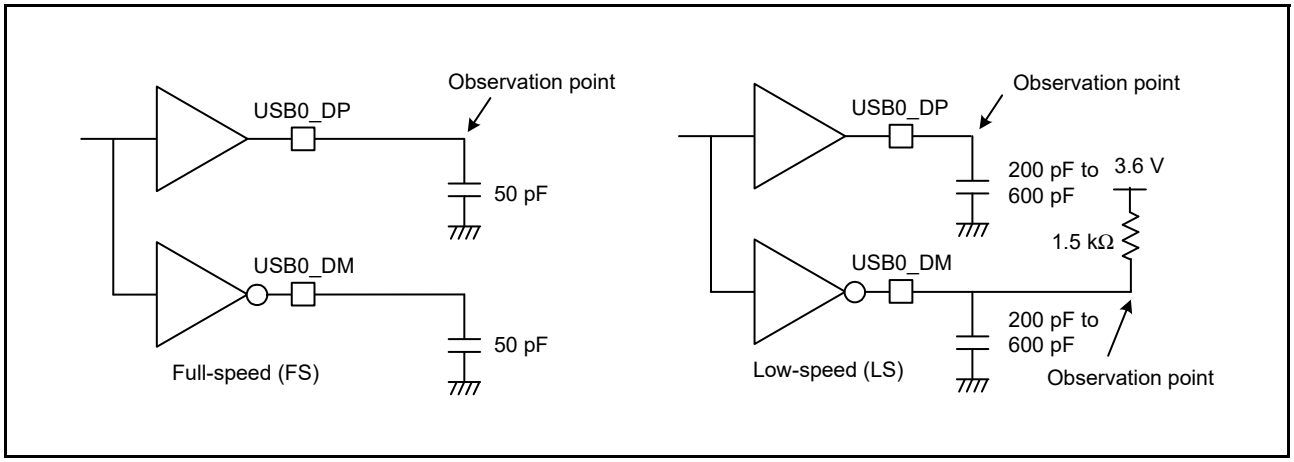


Figure 5.66 Test Circuit

Differential non-linearity error (DNL)

The differential non-linearity error is the difference between 1-LSB width based on the ideal A/D conversion characteristics and the width of the actual output code.

Offset error

An offset error is the difference between a transition point of the ideal first output code and the actual first output code.

Full-scale error

A full-scale error is the difference between a transition point of the ideal last output code and the actual last output code.

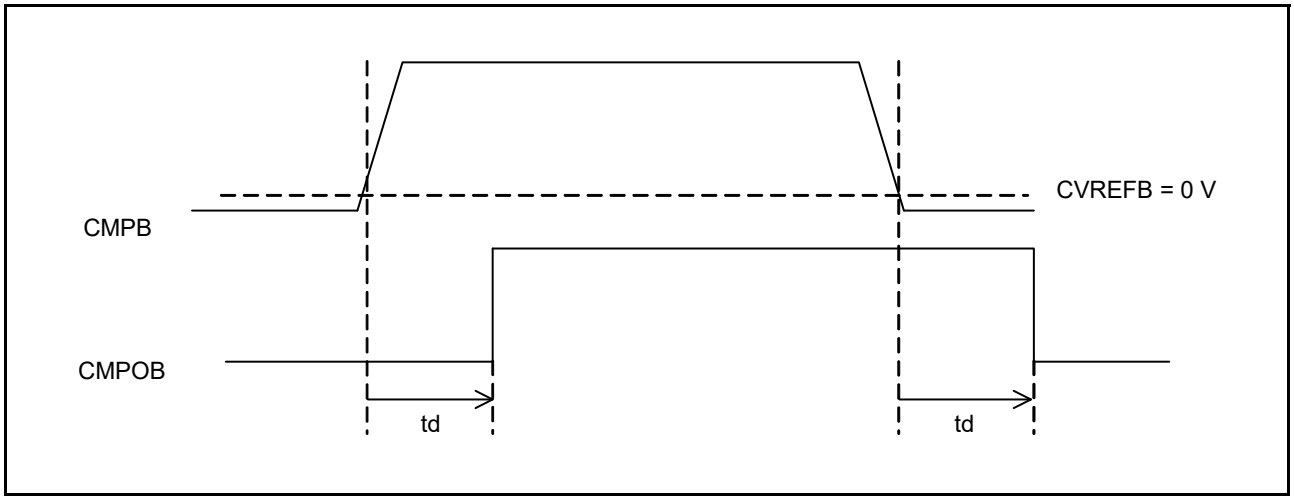


Figure 5.71 Comparator Output Delay Time in Comparator High-Speed Mode and Low-Speed Mode

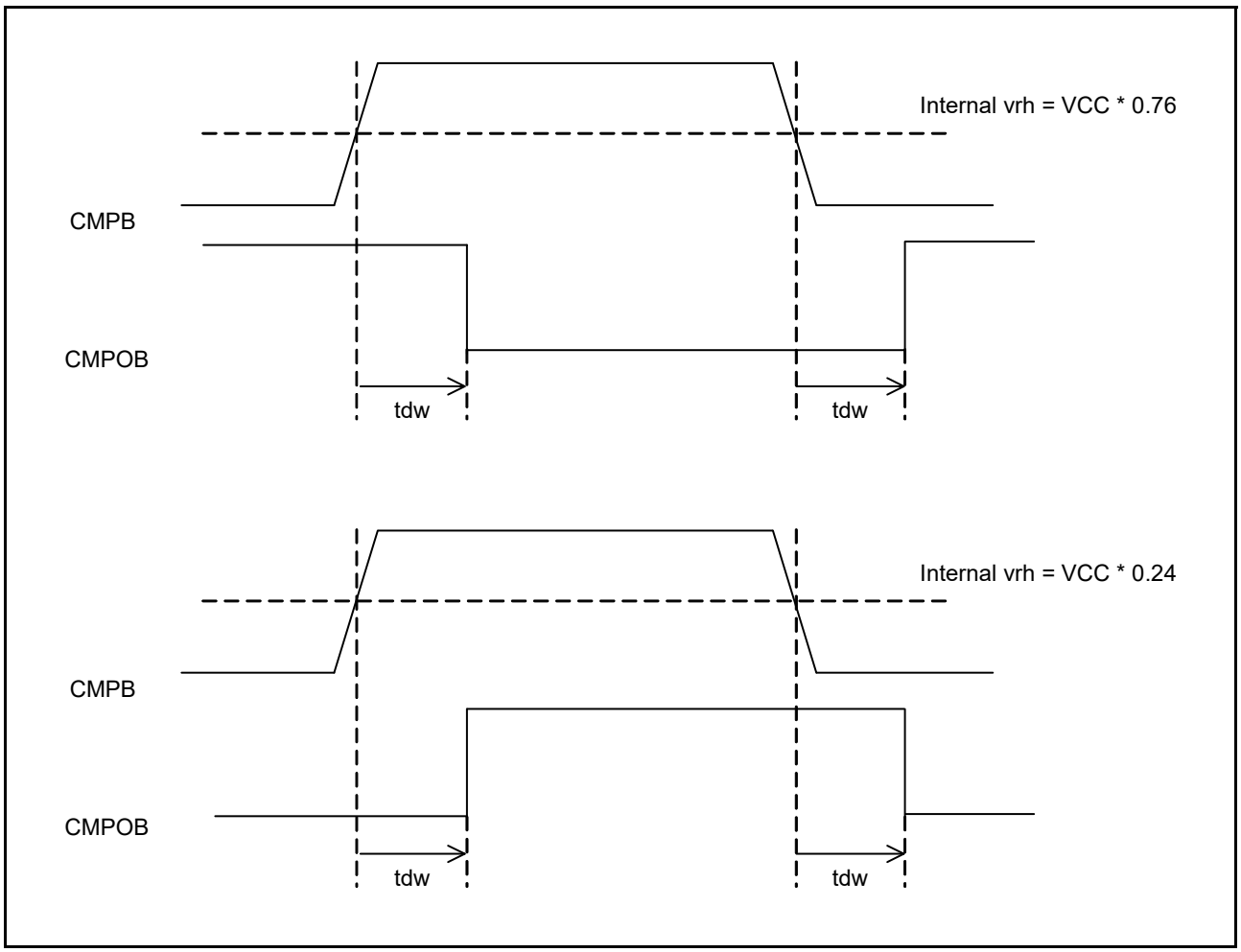
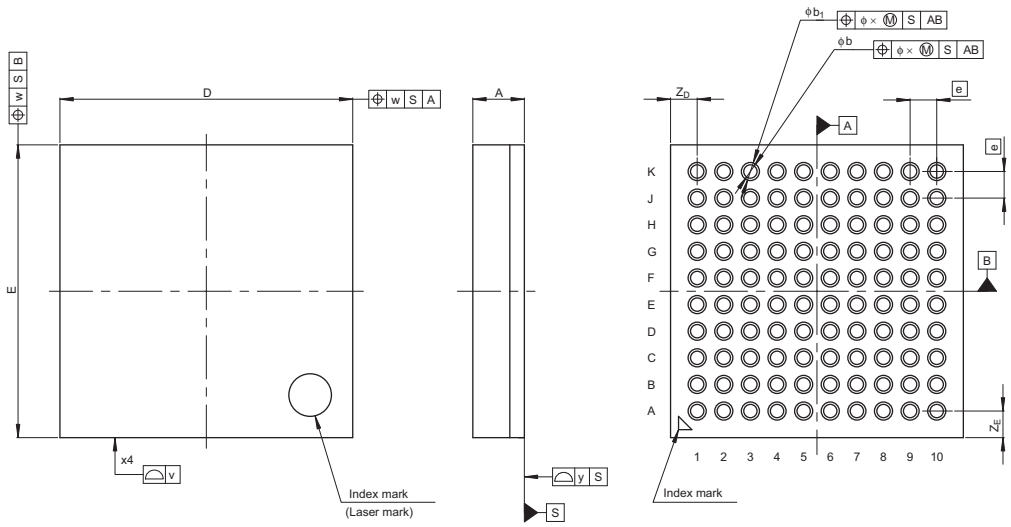


Figure 5.72 Comparator Output Delay Time in High-Speed Mode with Window Function Enabled

Appendix 1. Package Dimensions

Information on the latest version of the package dimensions or mountings has been displayed in “Packages” on Renesas Electronics Corporation website.

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-TFLGA100-5.5x5.5-0.50	PTLG0100KA-A	100F0M	0.1g



Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	—	5.5	—
E	—	5.5	—
v	—	—	0.15
w	—	—	0.20
A	—	—	1.05
e	—	0.5	—
b	0.21	0.25	0.29
b_1	0.29	0.34	0.39
x	—	—	0.08
y	—	—	0.08
Z_D	—	0.5	—
Z_E	—	0.5	—

Figure A 100 -Pin TFLGA (PTLG0100KA-A)